

C2012X8R2A333K125AB

TDK Item Description : C2012X8R2A333KT****



Application & Main Feature

Commercial Grade (High Temperature Application)

Series

C2012 [EIA CC0805]



Dimensions

- L 2.00mm +/-0.2mm
- W 1.25mm +/-0.2mm
- T 1.25mm +/-0.2mm
- B 0.20mm Min.
- G 1.00mm Min.

Temperature Characteristic

X8R (-55 to 150 degC +/-15%)

Rated Voltage

2A (100Vdc)

Capacitance

33nF

Capacitance Tolerance

K (+/-10%)

Dissipation Factor

3% Max.

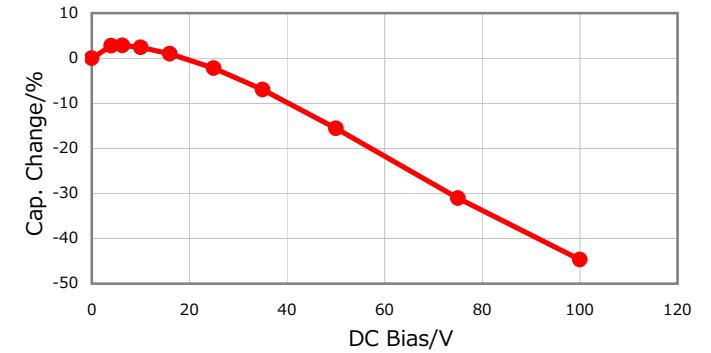
Insulation Resistance

10Gohm Min.

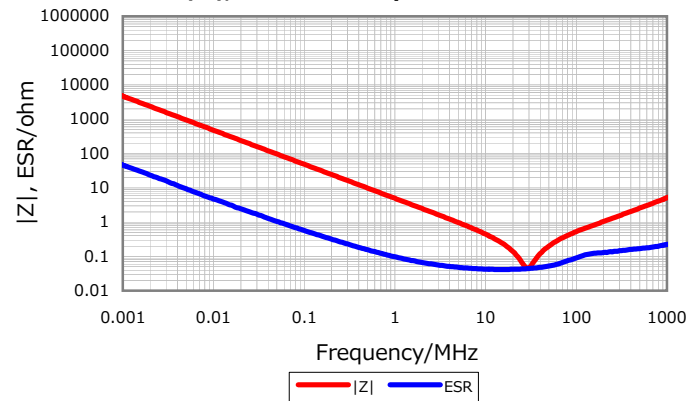
AEC-Q200

Not Applicable

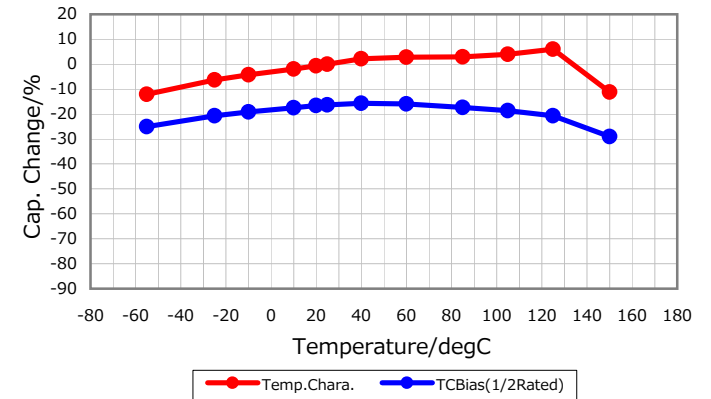
DC Bias Characteristic



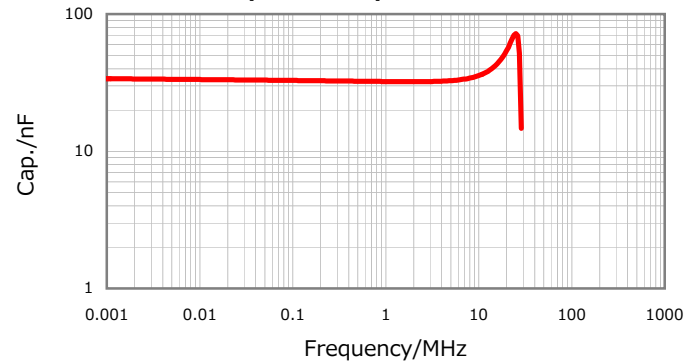
|Z|, ESR vs. Freq. Characteristics



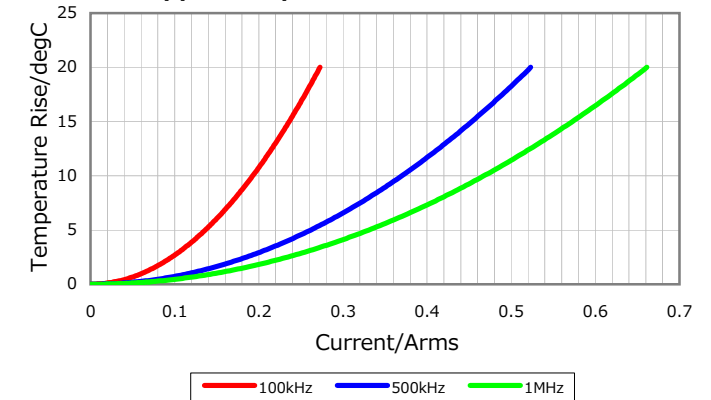
Temperature Characteristics



Cap. vs. Freq. Characteristic



Ripple Temperature Rise Characteristics



Characterization Sheet (Multilayer Ceramic Chip Capacitors)



⚠ All specifications are subject to change without notice.

January 3, 2016